TSMC99-646B





A F/2800 #1/ Amost C (#8) 6/24/or

To: Commissioner of Patents and Trademarks Washington, D.C. 20231

Fr: Stephen B. Ackerman, Reg. No. 37,761 20 McIntosh Drive Poughkeepsie, N.Y. 12603

Subject:

Serial No. 09/846,536

05/02/01

W. T. Chu et al

"SELF ALIGNED, LOW CONTACT RESISTANCE, VIA FABRICATION PROCESS"

GRP. Art. Unit 2811

O. Nadav

## **RESPONSE PATENT OFFICE ACTION**

Dear Sir;

In response to the FINAL Office Action dated April 26, 2002, please amend the identified application for patent as follows:

and the

The commissioner is hereby authorized to charge payment of any additional fees involved with added Claims and the like to Deposit Account No. 19-0033

## **CERTIFICATE OF MAILING**

I hereby certify that this correspondence is being deposited with the United States Postal Service as first class mail in an envelope addressed to: Commissioner of Patents and Trademarks, Washington, D.C. 20231, on May 20, 2002,

Stephen B. Ackerman, Reg. No. 37,761

Signature

Date 5/20/00